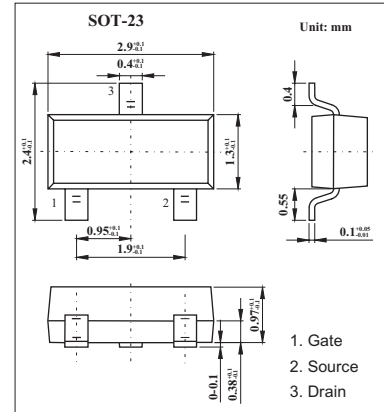
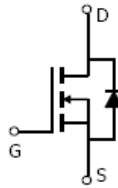


# KO3414(AO3414)

### Features

- $V_{DS} = 20V$
- $I_D = 4.2A$  ( $V_{GS}=4.5V$ )
- $R_{DS(ON)} < 50m\Omega$  ( $V_{GS} = 4.5V$ )
- $R_{DS(ON)} < 63m\Omega$  ( $V_{GS} = 2.5V$ )
- $R_{DS(ON)} < 87m\Omega$  ( $V_{GS} = 1.8V$ )



### Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 8$	V
Continuous Drain Current *1 $T_A=25^\circ C$	$I_D$	4.2	A
Current *1 $T_A=70^\circ C$		3.2	
Pulsed Drain Current *2	$I_{DM}$	15	
Power Dissipation *1 $T_A=25^\circ C$	$P_D$	1.4	W
$T_A=70^\circ C$		0.9	
Thermal Resistance.Junction-to-Ambient *1	$R_{thJA}$	125	$^\circ C/W$
Thermal Resistance.Junction-to-Case	$R_{thJC}$	80	$^\circ C/W$
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	$^\circ C$

\*1The value of  $R_{thJA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz.

Copper, in a still air environment with  $T_A = 25^\circ C$

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	20			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =16V, V <sub>GS</sub> =0V			1	μA
		V <sub>DS</sub> =16V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C			5	
Gate-Body leakage current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±8V			±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> I <sub>D</sub> =250μA	0.4	0.6	1	V
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =4.2A		41	50	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =4.2A T <sub>J</sub> =125°C		58	70	
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =3.7A		52	63	
		V <sub>GS</sub> =1.8V, I <sub>D</sub> =3.2A		67	87	
On state drain current	I <sub>D(ON)</sub>	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =5V	15			A
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =5V, I <sub>D</sub> =4.2A		11		S
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =-10V, f=1MHz		436		pF
Output Capacitance	C <sub>oss</sub>			66		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			44		pF
Gate resistance	R <sub>g</sub>		V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz		3	
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =-10V, I <sub>D</sub> =4.2A		6.2		nC
Gate Source Charge	Q <sub>gs</sub>			1.6		nC
Gate Drain Charge	Q <sub>gd</sub>			0.5		nC
Turn-On DelayTime	t <sub>D(on)</sub>	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =10V, R <sub>L</sub> =2.7Ω, R <sub>GEN</sub> =6Ω		5.5		ns
Turn-On Rise Time	t <sub>r</sub>			6.3		ns
Turn-Off DelayTime	t <sub>D(off)</sub>			40		ns
Turn-Off FallTime	t <sub>f</sub>			12.7		ns
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =4A, di/dt=100A/μs		12.3		ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> =4A, di/dt=100A/μs		3.5		nC
Maximum Body-Diode Continuous Current	I <sub>S</sub>				2	A
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =1A, V <sub>GS</sub> =0V		0.76	1	V